



COURSE INFORMATION				
<b>Course Code</b>	<b>EE 334</b>	<b>Course Title</b>	<b>Digital Electronic Circuits</b>	
<i>Semester</i>	<i>Credits</i>	<i>ECTS</i>	<i>C + P + L Hour</i>	<i>Prerequisites</i>
5, 6	4	7	3+0+2	EE 241 Digital Circuits

<b>Language of Instruction</b>	<b>Course Level</b>	<b>Course Type</b>
English	Undergraduate	Core
<b>Course Coordinator</b>	Uğur Çilingiroğlu	
<b>Instructors</b>	Uğur Çilingiroğlu	
<b>Assistants</b>	Ertuğ Erem	
<b>Goals</b>	Exposing all students to the technological foundations of contemporary digital integrated circuits and their design, and primes those students who prefer specializing later in microelectronics.	
<b>Content</b>	Evolutionary path of microelectronics. Technology and devices: CMOS technology; layout; MOSFET modeling; device and interconnection capacitances. Inverter: Ideal inverter; CMOS inverter; binary operation and restoration; dynamic properties; power consumption; inverter design. Static CMOS gates: NAND; NOR; complex gates; layout techniques for static CMOS gates. Pass logic: Pass-logic synthesis; NMOS and PMOS pass logic. Sequential circuits in static CMOS: SR flip flop; latch and register; register timing; synchronization and pipelining with latches and registers. Dynamic logic: Dynamic storage; dynamic latch and register; quasi-static latch; two-phase nonoverlapping clocking; dynamic logic gates. Semiconductor memories: Classification; random-access architecture; mask-programmable ROM; static RAM; dynamic RAM.	
<b>Contribution of the Course to the Professional Education</b>	Provides for fundamental competencies in the area of digital integrated circuit design	

<b>Course Learning Outcomes</b>	<b>Detailed Program Outcomes</b>	<b>Teaching Methods</b>	<b>Assessment Methods</b>
Proper use of MOSFET device models in digital integrated-circuit analysis and design.	2b	1, 2, 3, 4, 7	A, B, D
Performing computer-aided electrical simulation and physical design.	3a, 3b, 4b, 5b	1, 2, 3, 4, 7	A, B, D



Translating digital integrated-circuit performance specifications into design constraints.	2a	1, 2, 3, 4, 7	A, B, D
Analyzing a conventional CMOS digital integrated circuit.	2b	1, 2, 3, 4, 7	A, B, D
Recognition of conventional CMOS families of logic gates and memory devices.	1a	1, 2, 3, 4, 7	A, B, D

<b>Teaching Methods:</b>	1: Lecture by instructor, 2: Lecture by instructor with class discussion, 3: Problem solving by instructor, 4: Use of simulations, 5: Problem solving assignment, 6: Reading assignment, 7: Laboratory work, 8: Term research paper, 9: Presentation by guest speaker, 10: Sample Project Review, 11: Interdisciplinary group working, 12: ...
<b>Assessment Methods:</b>	A: Written exam, B: Multiple-choice exam C: Take-home quiz, D: Experiment report, E: Homework, F: Project, G: Presentation by student, H: ...

<b>COURSE CONTENT</b>		
<b>Week</b>	<b>Topics</b>	<b>Study Materials</b>
1	Introduction: Digital versus analog. Fundamental properties of digital circuits. Evolutionary dynamics of VLSI engineering.	
2	Technology and devices: CMOS technology. Layout design rules. MOSFET modeling for digital design.	
3	Technology and devices: MOSFET modeling for digital design.	
4	Technology and devices: Device and interconnection capacitances. Inverter: Ideal inverter.	
5	Inverter: CMOS inverter voltage-transfer characteristics. Binary operation and restoration.	
6	Inverter: Dynamic characteristics. Power dissipation. Inverter design.	
7	Static logic gates: NAND gate. NOR gate. Complex gates.	
8	Static logic gates: Complex gates. Layout techniques for static CMOS gates. Pass-logic gates: NMOS pass logic.	
9	Pass-logic gates: CMOS pass logic.	
10	Sequential Circuits in Static CMOS: SR flip flops. Clocked SR flip-flops. Latch. Register.	
11	Sequential Circuits in Static CMOS: Latch and register timing. Synchronization and pipelining. Dynamic logic: Dynamic storage.	



12	Dynamic logic: Dynamic latches and registers. Pseudo-Static Latch and register.	
13	Dynamic logic: Dynamic logic gates. Semiconductor memories: Taxonomy. Random-access architecture. Mask-programmed ROM.	
14	Semiconductor memories: Static RAM. Dynamic RAM.	

#### RECOMMENDED SOURCES

<b>Textbook</b>	Lecture notes: Digital Integrated-Circuit Design by Uğur Çilingiroğlu (Distributed electronically).
<b>Additional Resources</b>	

#### MATERIAL SHARING

<b>Documents</b>	'Ngspice' circuit analysis software. 'Electric' physical design software. Lecture notes.
<b>Assignments</b>	
<b>Exams</b>	Midterm exam papers and solutions.

#### ASSESSMENT

IN-TERM STUDIES	NUMBER	PERCENTAGE
Mid-term exams	2	45/75
Quiz	Variable	10/75
Laboratory	12 sessions	20/75
<b>Total</b>		<b>100</b>
<b>CONTRIBUTION OF FINAL EXAMINATION TO OVERALL GRADE</b>		25/100
<b>CONTRIBUTION OF IN-TERM STUDIES TO OVERALL GRADE</b>		75/100
<b>Total</b>		<b>100</b>

<b>COURSE CATEGORY</b>	Field Course
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#### COURSE'S CONTRIBUTION TO PROGRAM OUTCOMES



No	Program Learning Outcomes	check √
1a	Adequate knowledge in mathematics, science and engineering subjects pertaining to the relevant discipline,	✓
1b	Ability to use theoretical and applied knowledge in these areas in complex engineering problems.	
2a	Ability to identify, formulate, and solve complex engineering problems,	✓
2b	Ability to select and apply proper analysis and modeling methods for this purpose.	✓
3a	Ability to design a complex system, process, device or product under realistic constraints and conditions, in such a way as to meet the desired result,	✓
3b	Ability to apply modern design methods for this purpose.	✓
4a	Ability to devise, select and use modern techniques and tools needed for analyzing and solving complex problems encountered in engineering practice.	
4b	Ability to employ information technologies effectively.	✓
5a	Ability to design experiments for investigating complex engineering problems or discipline specific research questions,	
5b	Ability to conduct experiments, gather data, analyze and interpret results for investigating complex engineering problems or discipline specific research questions.	✓
6a	Ability to work efficiently in intra-disciplinary teams,	
6b	Ability to work efficiently in multi-disciplinary teams,	
6c	Ability to work individually.	
7a	Ability to communicate effectively in Turkish, both orally and in writing,	
7b	Knowledge of a minimum of one foreign language,	
7c	Ability to write effective reports and comprehend written reports, prepare design and production reports,	
7d	Ability to make effective presentations,	
7e	Ability to give and receive clear and intelligible instructions.	
<b>8a</b>	Recognition of the need for lifelong learning, ability to access information, ability to follow developments in science and technology,	
<b>8b</b>	Ability to continue to educate him/herself.	
<b>9a</b>	Consciousness to behave according to ethical principles and professional and ethical responsibility.	
<b>9b</b>	Knowledge on standards used in engineering practice.	
<b>10a</b>	Knowledge about business life practices such as project management, risk management, change management.	
<b>10b</b>	Awareness in entrepreneurship and innovation.	



<b>10c</b>	Knowledge about sustainable development.	
<b>11a</b>	Knowledge about the global and social effects of engineering practices on health, environment, and safety,	
<b>11b</b>	Knowledge about contemporary issues of the century reflected into the field of engineering.	
<b>11c</b>	Awareness of the legal consequences of engineering solutions.	

<b>ECTS ALLOCATED BASED ON STUDENT WORKLOAD BY THE COURSE DESCRIPTION</b>			
Activities	Quantity	Duration (Hour)	Total Workload (Hour)
Course Duration	14	5	70
Hours for off-the-classroom study (Pre-study, practice)	14	7	98
Mid-terms	2	2	4
Homework			
Final examination	1	2	2
<b>Total Work Load</b>			174
<b>Total Work Load / 25 (h)</b>			6.96
<b>ECTS Credit of the Course</b>			7

Prepared by: Uğur Çilingiroğlu	Preparation date: September 2, 2019
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